

**LED DISPLAY****LTP-14088KD-J**  
**DATA SHEET**

<b>Rev</b>	<b>Description</b>	<b>By</b>
01	RDR Original Spec	Phanomkorn J. December 01, 2008
-	NPPR Original Spec	Phanomkorn J. December 19, 2008

SPEC. NO.: DS30-2008-0194D A T E : December 19, 2008REV. NO. : -PAGE NO. : 0 OF 5

**FEATURES**

- \* 1.50 inch ( 37.0 mm) MATRIX HEIGHT
- \* LOW POWER REQUIREMENT
- \* SINGLE PLANE, WIDE VIEWING ANGLE
- \* SOLID STATE RELIABILITY
- \* 8 ×8 ARRAY WITH X-Y SELECT
- \* COMPATIBLE WITH USASCII AND EBCDIC CODES
- \* STACKABLE HORIZONTALLY
- \* CATEGORIZED FOR LUMINOUS INTENSITY
- \* **LEAD-FREE PACKAGE (ACCORDING TO RoHS)**

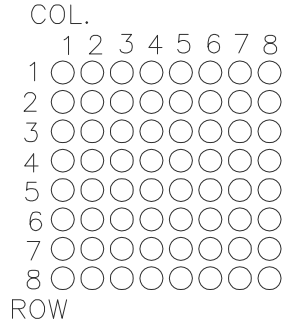
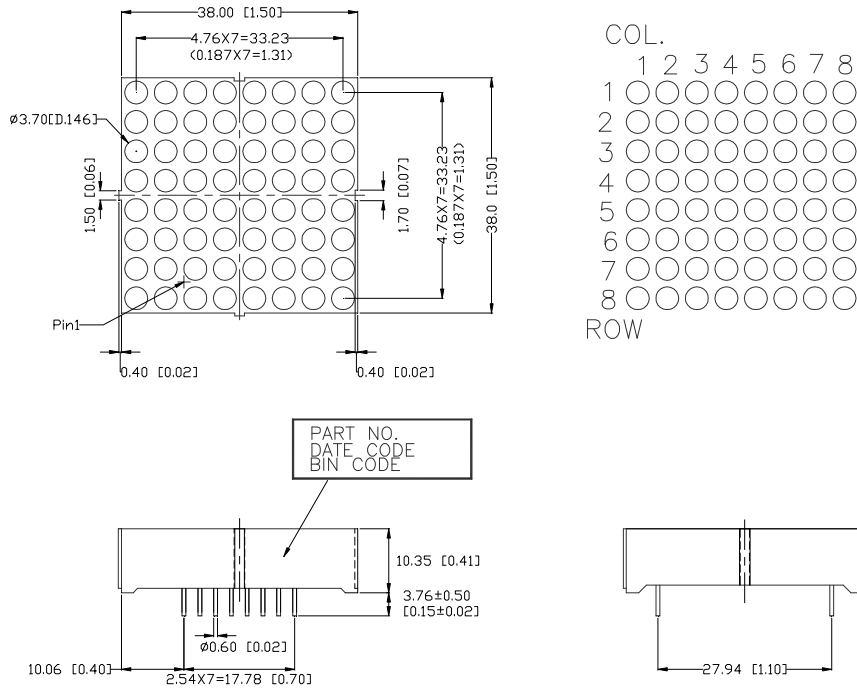
**DESCRIPTION**

The LTP-14088KD-J is a 1.50 inch (37.0 mm) matrix height 8×8 dot matrix display. This device uses AS-AllnGaP Hyper Red LED chips (AllnGaP epi on GaAs substrate). The matrix display has a black face and white dot color.

**DEVICE**

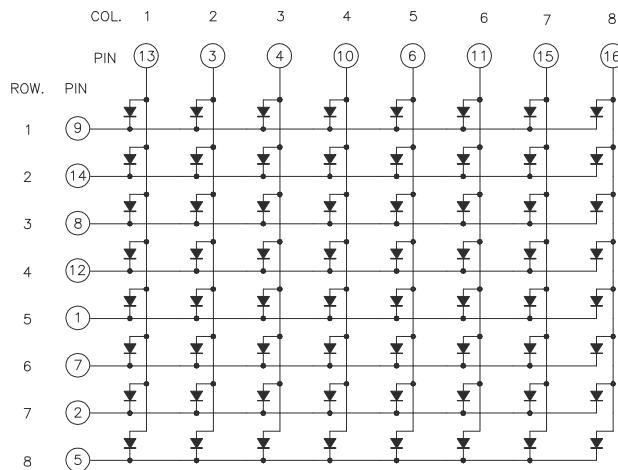
<b>PART NO.</b>	<b>DESCRIPTION</b>
AllnGaP Hyper Red	Anode Column
LTP-14088KD-J	Cathode Row

## PACKAGE DIMENSIONS



- NOTES: 1. All dimensions are in millimeters. Tolerances are  $\pm 0.25$  mm (0.01") unless otherwise noted.
- Pin tip's shift tolerance is  $\pm 0.4$  mm.
  - Foreign material on segment  $\leq 10$  mils
  - Ink contamination (surface)  $\leq 20$  mils
  - Bending  $\leq 1/100$
  - Bubble in segment  $\leq 10$  mils

## INTERNAL CIRCUIT DIAGRAM



**PIN CONNECTION**

<b>NO</b>	<b>CONNECTION</b>
1	CATHODE ROW 5
2	CATHODE ROW 7
3	ANODE COLUMN 2
4	ANODE COLUMN 3
5	CATHODE ROW 8
6	ANODE COLUMN 5
7	CATHODE ROW 6
8	CATHODE ROW 3
9	CATHODE ROW 1
10	ANODE COLUMN 4
11	ANODE COLUMN 6
12	CATHODE ROW 4
13	ANODE COLUMN 1
14	CATHODE ROW 2
15	ANODE COLUMN 7
16	ANODE COLUMN 8

## ABSOLUTE MAXIMUM RATING

PARAMETER	MAXIMUM RATING	UNIT
Average Power Dissipation Per Dot	70	mW
Peak Forward Current Per Dot ( Frequency 1Khz,18% duty cycle)	90	mA
Average Forward Current Per Dot	25	mA
Derating Linear From 25°C Per Dot	0.28	mA/°C
Reverse Voltage Per Segment	5	V
Operating Temperature Range	-35°C to +105°C	
Storage Temperature Range	-35°C to +105°C	
Soldering Conditions: 1/16 inch below seating plane for 3 seconds at 260 <sup>0</sup> C or of temperature unit (during assembly) not over max. temperature rating above.		

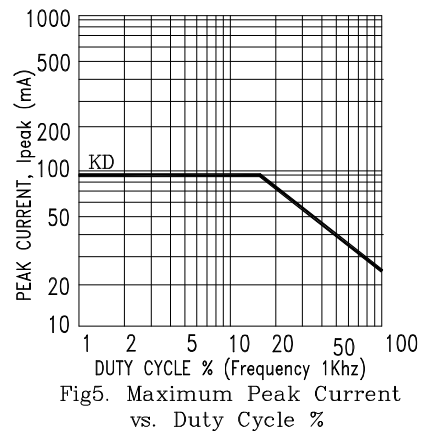
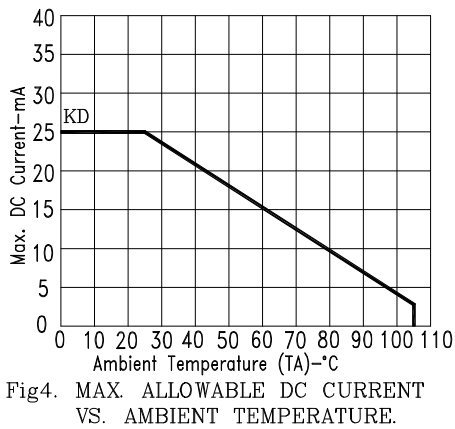
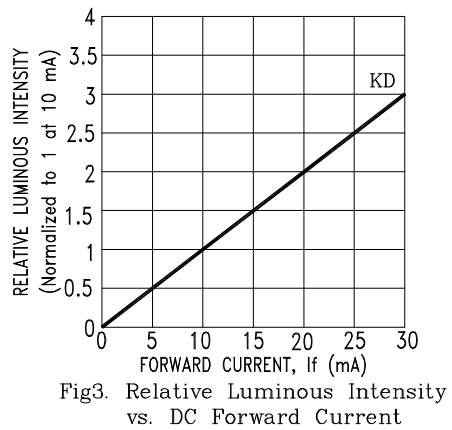
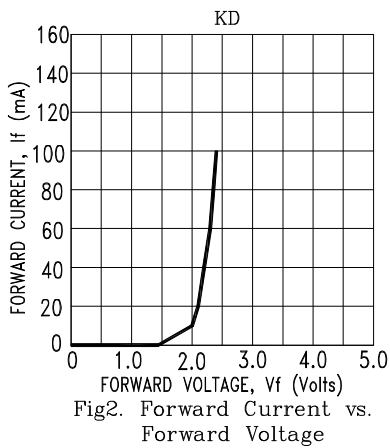
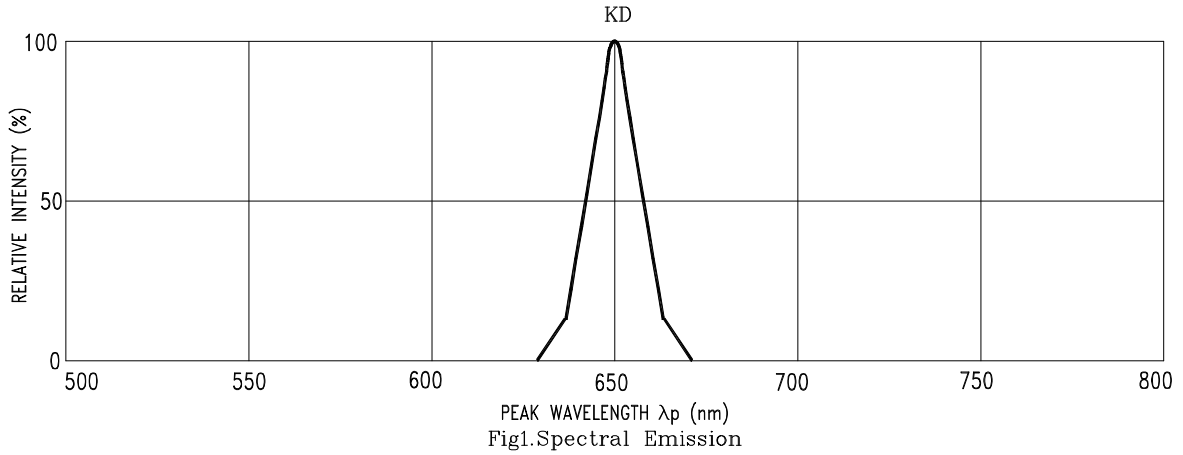
## ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta=25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Average Luminous Intensity	I <sub>v</sub>	1020	2475		μcd	I <sub>p</sub> =32mA 1/16Duty
Peak Emission Wavelength	λ <sub>p</sub>		650		nm	I <sub>F</sub> =20mA
Spectral Line Half-Width	Δλ		20		nm	I <sub>F</sub> =20mA
Dominant Wavelength	λ <sub>d</sub>		639		nm	I <sub>F</sub> =20mA
Forward Voltage any Dot	V <sub>F</sub>		2.1	2.6	V	I <sub>F</sub> =20mA
			2.3	2.8		I <sub>F</sub> =80mA
Reverse Current any Dot	I <sub>R</sub>			100	μA	V <sub>R</sub> =5V
Luminous Intensity Matching Ratio (Similar Light Area)	I <sub>v-m</sub>			2:1		I <sub>p</sub> =32mA 1/16Duty

Note: Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commision Internationale De L'Eclairage) eye-response curve.

**TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES**

(25°C Ambient Temperature Unless Otherwise Noted)



NOTE : KD=AlInGaP HYPER RED